Photomicrosensor (Reflective)

EE-SY199

Ultra-compact SMD Type with a detectable sensing distance of 1 mm

- PCB surface mounting type.
- Support for small lots. *1
- Sorting specifications available. *2



Be sure to read Safety Precautions on page 3.

RoHS Compliant



Model Number Structure

EE-S 99

(1) (1)

(2)

(3) (2)

(4) (3)

(4)

Photomicrosensor

Reflective

Phototransistor output

Serial number

Ordering Information

Photomicrosensor

Appearance	Sensing method	Connecting method	Sensing distance	Output type	Model	Minimum packing unit (Unit: pcs)
3.2	Reflective	SMT	1 mm	Phototransistor	EE-SY199 *1 *2	2,000 *1

^{*1.} Types with 100 pcs/box re available. The model name for ordering is EE-SY199-1.

Note: Order in multiples of minimum packing unit.

Ratings, Characteristics and Exterior Specifications

Absolute Maximum Ratings (Ta = 25°C)

			5.	
Item		Symbol	Rated value	Unit
Emitter				
	Forward current	lF	50 * ¹	mA
	Reverse voltage	VR	6	V
Detector				
	Collector-Emitter voltage	VCEO	35	V
	Emitter-Collector voltage	VECO	6	V
	Collector current	Ic	20	mA
	Collector dissipation	Pc	75 * ¹	mW
Total allowable loss		Ptot	100 *1	mW
Operating temperature		Topr	-25 to 85	°C
Storage temperature		T _{stg}	-40 to 100	°C
Reflow soldering temperature		Tsol	260 *2	°C

^{*1.} Refer to the temperature rating chart if the ambient temperature exceeds 25°C.

Exterior Specifications

Connecting method	Weight (g)	Material		
Connecting method	Weight (g)	Case		
SMT	0.008	Polyphenylene sulfide (PPS)		

Electrical and Optical Characteristics (Ta = 25°C)

lhows		Sym	Sym Value		Unit	0 1212			
Item			bol	MIN.	TYP.	MAX.	Unit	Condition	
E	Emitter								
	Forward current		VF		1.2	1.4	V	IF = 20 mA	
Reverse voltage		lR			10	μΑ	V _R = 6 V		
Peak emission wavelength		λР		950		nm			
D	Detector								
	Light	EE-SY199	- L	40	85	130	μА	IF = 4 mA, VcE = 2 V, Aluminum-deposited surface, d = 1 mm *	
	current	EE-SY199- RANKB	IL	65					
	Dark current		ΙD		1	100	nA	Vce = 20 V, 0 ℓx	
	Leakage	current	 LEAK			500	nA	IF = 4 mA, VcE = 2 V, with no reflection	
	Collector-Emitter saturated voltage		V _{CE} (sat)				٧		
Peak spectral sensitivity wavelength		λР		930		nm			
Rising time		tr		20	100	μА	$\begin{aligned} &V_{\text{CC}} = 2 \text{ V, } R_{\text{L}} = 1 \text{ k}\Omega, \\ &I_{\text{L}} = 100 \mu\text{A, } d = 1 \text{ mm }^* \end{aligned}$		
Falling time			tf		20	100	μΑ	$\label{eq:Vcc} \begin{array}{l} \mbox{Vcc} = 2 \mbox{ V, } \mbox{RL} = 1 \mbox{ k}\Omega, \\ \mbox{IL} = 100 \mu\mbox{A, } \mbox{d} = 1 \mbox{ mm} ^{\star} \end{array}$	

^{*} Refer to Fig 12. Light Current Measurement Setup Diagram on page 2.

^{*2.} Photocurrent types available. The model name for ordering is EE-SY199-RANKB.

^{*2.} Complete soldering within 5 seconds. For reflow soldering, use the conditions given on page 5.

Engineering Data (Reference value)

Fig 1. Forward Current vs. Collector **Dissipation Temperature Rating**

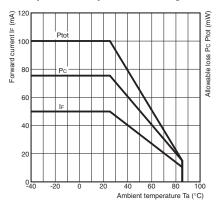


Fig 4. Light Current vs. Collector-Emitter **Voltage Characteristics (Typical)**

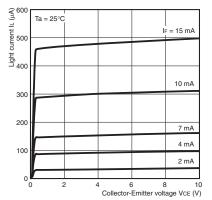


Fig 7. Response Time vs. Load **Resistance Characteristics (Typical)**

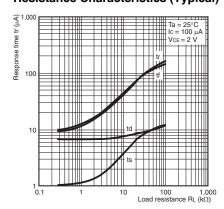


Fig 10. Relative Light Current vs. Card **Moving Distance Characteristics (Typical)**

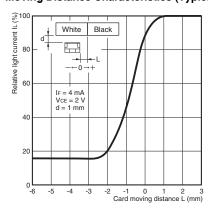


Fig 2. Forward Current vs. Forward **Voltage Characteristics (Typical)**

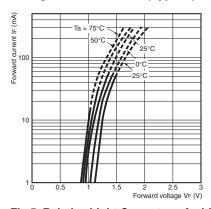


Fig 5. Relative Light Current vs. Ambient Fig 6. Dark Current vs. Ambient **Temperature Characteristics (Typical)**

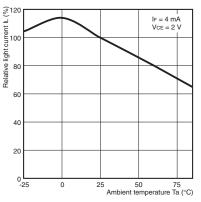


Fig 8. Relative Light Current vs. **Distance Characteristics (Typical)**

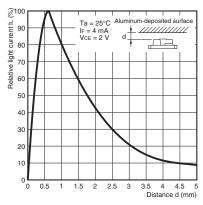


Fig 11. Response Time Measurement Circuit

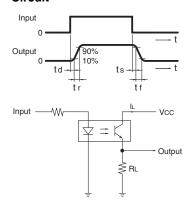
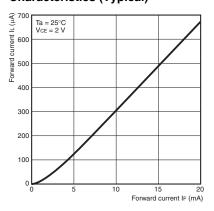


Fig 3. Light Current vs. Forward Current **Characteristics (Typical)**



Temperature Characteristics (Typical)

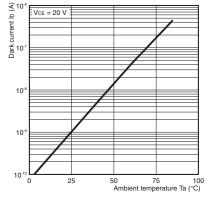


Fig 9. Relative Light Current vs. Card **Moving Distance Characteristics (Typical)**

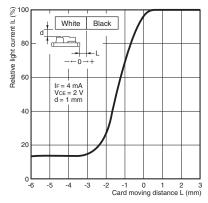
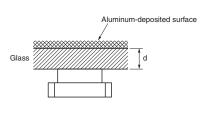


Fig 12. Light Current Measurement Setup Diagram



Safety Precautions

To ensure safe operation, be sure to read and follow the Instruction Manual provided with the Sensor.

⚠ CAUTION

This product is not designed or rated for ensuring safety of persons either directly or indirectly. Do not use it for such purposes.



Precautions for Safe Use

Do not use the product with a voltage or current that exceeds the rated range.

Applying a voltage or current that is higher than the rated range may result in explosion or fire.

Do not miswire such as the polarity of the power supply voltage.

Otherwise the product may be damaged or it may burn.

This product does not resist water. Do not use the product in places where water or oil may be sprayed onto the product.

Precautions for Correct Use

Do not use the product in atmospheres or environments that exceed product ratings. This product is for surface mounting. Refer to Soldering Information, Storage and Baking for details.

Dispose of this product as industrial waste.

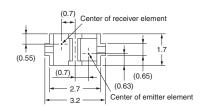
Dimensions and Internal Circuit

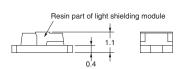
(Unit: mm)

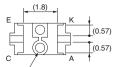
Photomicrosensor

EE-SY199





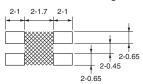




Direction pattern (NC)

Terminal No.	Name		
Α	Anode		
K	Cathode		
С	Collector		
Е	Emitter		

Recommended Soldering Pattern

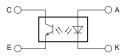


Note: 1. The shaded portion in the above figure may cause shorting.

Do not wire in this portion.

 The dimensional tolerance for the recommended soldering pattern is ±0.1 mm.

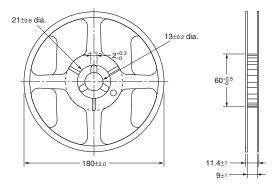
Internal circuit



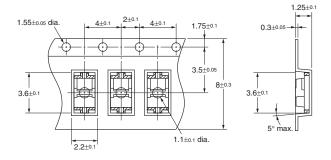
Unless otherwise specified, the dimensional tolerance is ±0.15 mm.

Tape and Reel

Reel (Unit: mm) *

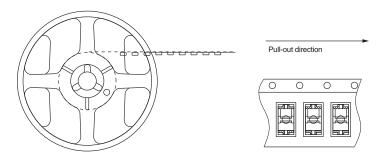


Tape (Unit: mm)



Part Mounting

The devices are oriented in the rectangular holes in the carrier tape so that the edge with the LED faces the round feeding holes.



Tape quantity

2,000 pcs./reel 100 pcs./pack *

 $^{\star}\,$ EE-SY199-1 (100 pcs./pack) has no reel, only tape is attached.

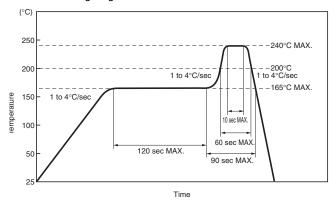
Packing Specifications

- One reel is sealed in an aluminum-laminated bag.
- The model number, lot number, and quantity are given on the label.

Soldering Information

Reflow soldering: Temperature profile

The reflow soldering must be completed in one time and must comply with the following diagram.



Solder Quantity

The pin's wiring pattern between the package and the board must not be soldered. Doing so would result in damage to the product's reliability. Make sure to adjust the solder quantity to the product sidewall of the terminal.

Other Notes

- The use of an infrared lamp causes the temperature of the resin to rise partially too high.
- Do not immerse the resin part into the solder.
- Test the soldering method under actual conditions and make sure the soldering works fine, since the impact on the junction between the device and PCB varies depending on the cooling and soldering conditions.

Storage

Storage conditions

Store the product under the following conditions:

Temperature: 5 to 30 °C Humidity: 70% max.

Treatment after open

- 1. After opening the bag, store the products between 5 and 25°C at 60% humidity or lower and mount them within two days.
- 2. If storage for longer than two days after opening the bag is required, use a dry box or reseal the products in a moisture-proof bag with a commercially available desiccant. Store them between 5 and 30°C at 70% humidity or lower, and mount them within two weeks.

Cleaning Conditions

Cleaning in Solvent:

Solvent temperature: 45°C max. Immersion time: 3 hours max.

Ultrasonic Cleaning:

Do not use ultrasonic cleaning.

Recommended Solvents:

Ethyl alcohol, methyl alcohol, or isopropyl alcohol

Baking

If the above treatment could not be carried out, mounting is still possible after baking treatment.

However, baking treatment must be limited to only one time. Recommended conditions: 125°C, 16 to 24 hours

Note: Do not bake the products while they are still in the bag. Temporarily mount them to the PCB or place them in metal trays.

Please check each region's Terms & Conditions by region website.

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